Silicon N Channel MOS FET High Speed Power Switching

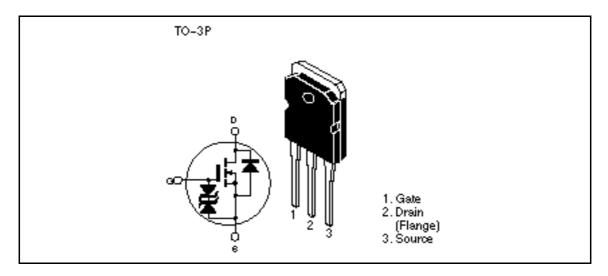


ADE-208-455 A 2nd. Edition

#### Features

- Low on-resistance
- High speed switching
- Low drive current
- Avalanche ratings

#### Outline





### **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	500	V	
Gate to source voltage	V <sub>GSS</sub>	±30	V	
Drain current	I <sub>D</sub>	20	А	
Drain peak current	L <sub>D(pulse)</sub> *1	80	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	20	А	
Avalanche current	l* <sup>3</sup>	20	А	
Avalanche energy	E <sub>AR</sub> * <sup>3</sup>	22	mJ	
Channel dissipation	Pch* <sup>2</sup>	150	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
Noton 1 DW 10 up duty avala 1 %				

Notes: 1. PW 10 $\mu$ s, duty cycle 1 %

2. Value at  $Tc = 25^{\circ}C$ 

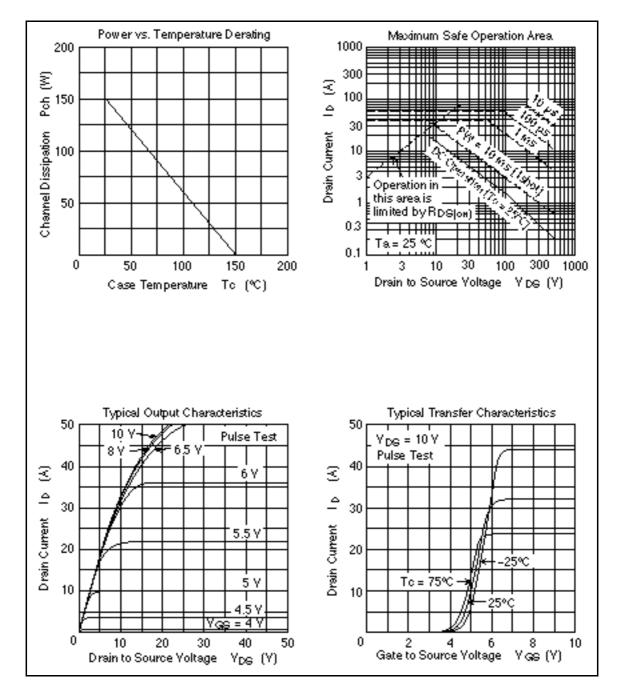
3. Value at Tch = 25°C, Rg  $\,$  50  $\,$  , L = 100  $\mu H$ 

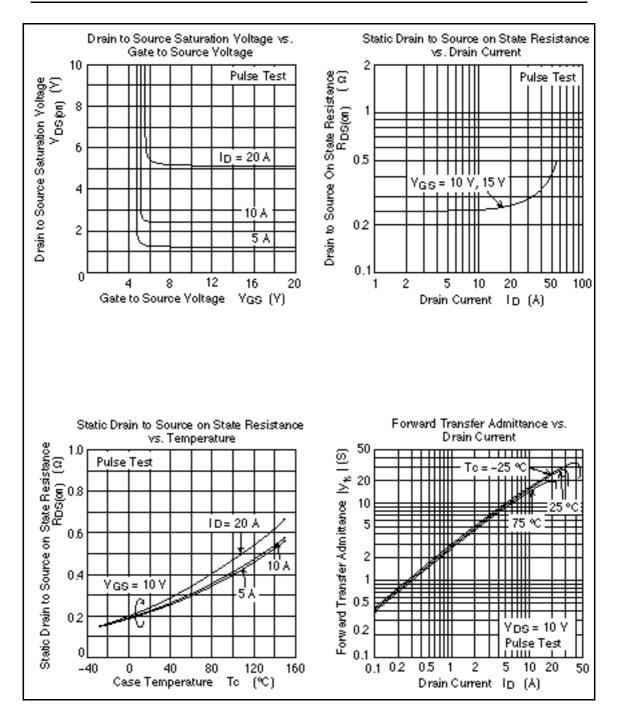
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	500	_	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±30	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μA	$V_{GS} = \pm 25V, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	—	10	μΑ	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.5	_	3.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V <sup>*1</sup>
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.24	0.29		$I_{\rm D} = 10$ A, $V_{\rm GS} = 10$ V <sup>*1</sup>
Forward transfer admittance	y <sub>fs</sub>	9	15		S	$I_{\rm D} = 10$ A, $V_{\rm DS} = 10$ V <sup>*1</sup>
Input capacitance	Ciss	_	3300	_	pF	$V_{DS} = 10V$
Output capacitance	Coss	_	900	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	120	_	pF	f = 1MHz
Total gate charge	Qg	_	55	_	nc	$V_{DD} = 400 V$
Gate to source charge	Qgs	_	14	_	nc	$V_{GS} = 10V$
Gate to drain charge	Qgd	_	17	_	nc	$I_{D} = 20A$
Turn-on delay time	t <sub>d(on)</sub>	_	45	_	ns	$V_{GS} = 10V, I_{D} = 10A$
Rise time	t,	_	140	_	ns	$R_{L} = 3$
Turn-off delay time	$t_{d(off)}$		150		ns	_
Fall time	t <sub>f</sub>	—	85		ns	
Body to drain diode forward voltage	$V_{DF}$	—	1.0	—	V	$I_{\rm D} = 20$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	400	—	ns	$I_{F} = 20A, V_{GS} = 0$ diF/ dt = 100A/µs
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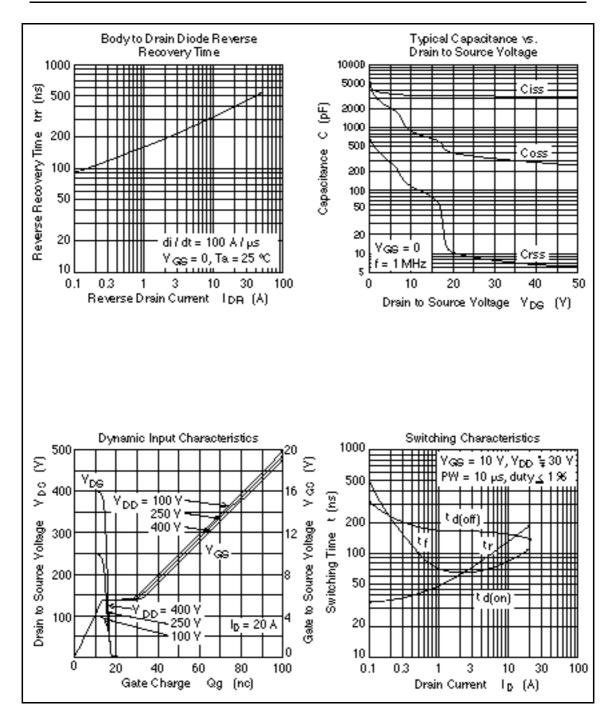
# **Electrical Characteristics** (Ta = $25^{\circ}$ C)

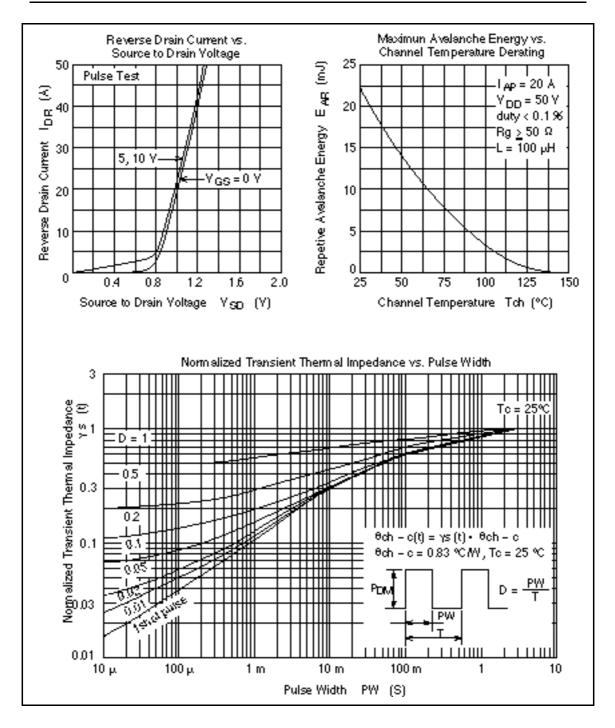
Note: 1. Pulse test

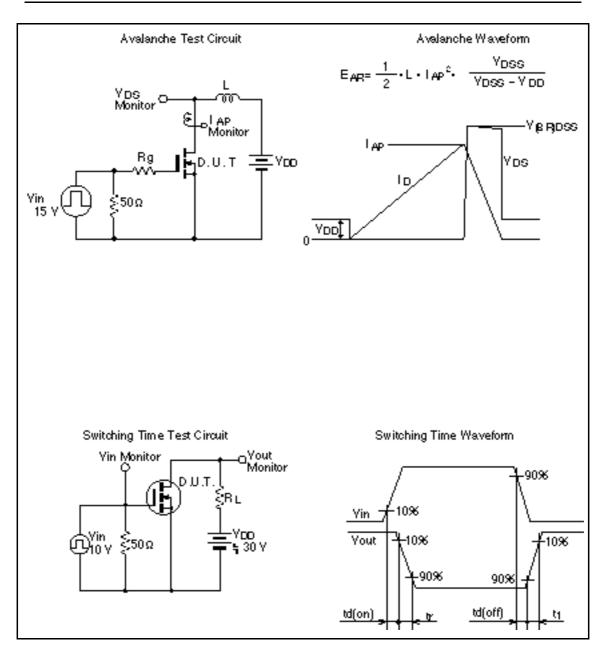
#### **Main Characteristics**



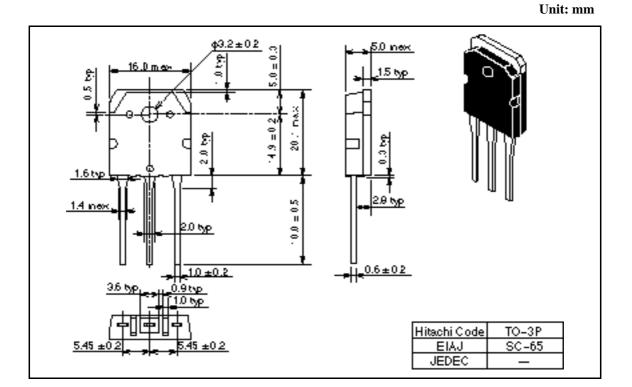








## **Package Dimentions**



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# HITACHI

Hitachi, Ltd.

Semiconductor & IC DV. Neppon Bidg, 2-5-2, Ohte-mach, Chiyoda-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-2111 Fax (03, 3270-5109

For Author in forms ion write to : Hischi America, Utd Semiconductor & IC DV. 2000 Sierra Point Parkway Briebana, CA. 94005-4835 U S.Å Tet 415-583-8300 Fax: 415-583-4207

Hischi Burope GmbH Bedronic Components Group Ominertel Burope Danischer Straße 3 D-85522 Fildkirchen Minchen Tet 089-9 94 80-0 Fex: 089-9 29 30 00 Hischi Burope Ltd. Bectronic Components Dw. Northern Burope Headquerters Whitebrook Ferk Lower Cook hem Roed Meidenheed Berkshire SL68YÅ United Kingdom Tet: 0628-585000 Fex: 0628-778322 Hitschi Asia Pte. Ltd 45 Collyer Quay \$20:00 Hitschi Tower Singspore 0:104 Tet 535-2100 Fex 535-1533

Hitschi Asia (Hong Kong) Ltd. Unit 705, North Tower, World Finance Cantre, Harbour City, Carton Road Taim She Taui, Kowloon Hong Kong Tet 27359218 Fax: 27359218